

Product data sheet

1. General description

Ultrafast power diode in a SMC package.

2. Features and benefits

- Fast switching
- SMC package
- High voltage capability
- Low forward voltage drop
- Low leakage current
- Low thermal resistance
- Soft recovery characteristic

3. Applications

- Discontinuous Current Mode (DCM) Power Factor Correction (PFC)
- · High frequency switched-mode power supplies

4. Quick reference data

Table 1. Quick reference d

Symbol	Parameter	Conditions	Values		Unit		
Absolute	maximum rating						
V_{RRM}	repetitive peak reverse voltage			600			V
I _{F(AV)}	average forward current	δ = 0.5 ; square-wave pulse; T _{lead} ≤ 96 °C; Fig. 1; Fig. 2; Fig. 3		5			A
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t _p = 25 μs; T _{lead} ≤ 96 °C; square-wave pulse	10		A		
I_{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 4	130 143			A	
		t_{p} = 8.3 ms; $T_{j(\text{init})}$ = 25 °C; sine-wave pulse;			А		
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static ch	aracteristics						
V _F	forward voltage	I _F = 5 A; T _j = 25 °C; <u>Fig. 6</u>		-	1.10	1.35	V
		I _F = 5 A; T _j = 150 °C; <u>Fig. 6</u>		-	0.9	1.15	V
Dynamic	characteristics				,		
t _{rr}	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 50 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$		-	45	-	ns

5. Pinning information

Table 2. Pinning information							
Pin	Symbol	Description	Simplified outline	Graphic symbol			
1	K	cathode		K — A 001aaa020			
2	А	anode	1	2			

6. Ordering information

Table 3. Ordering information						
Type number	pe number Package					
	Name	Description	Version			
MUR560	SMC	Hermetically sealed plastic package; SMC; 2 leads	SMC			

7. Marking

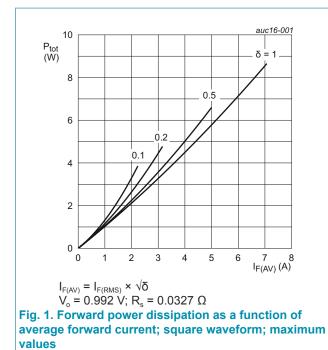
Table 4. Marking codes						
Type number	Marking codes					
MUR560	560					

8. Limiting values

Table 5. Limiting values

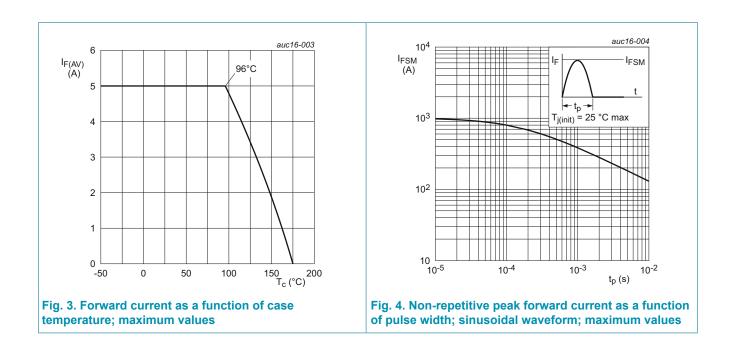
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{RRM}	repetitive peak reverse voltage		600	V
V _{RWM}	crest working reverse voltage		600	V
V _R	reverse voltage	DC	600	V
I _{F(AV)}	average forward current	δ = 0.5; square-wave pulse; T _{lead} ≤ 96 °C; Fig. 1; Fig. 2; Fig. 3	5	A
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t _p = 25 μs; T _{lead} ≤ 96 °C; square-wave pulse	10	A
I _{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 4	130	A
		t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse;	143	А
T _{stg}	storage temperature		-65 to 175	°C
Tj	junction temperature		175	°C



auc16-002 8 P_{tot} (W) a = 1.57 6 1.9 2.2 2.8 4 4.0 2 0 0 1 2 3 4 5 I_{F(AV)} (A) 6

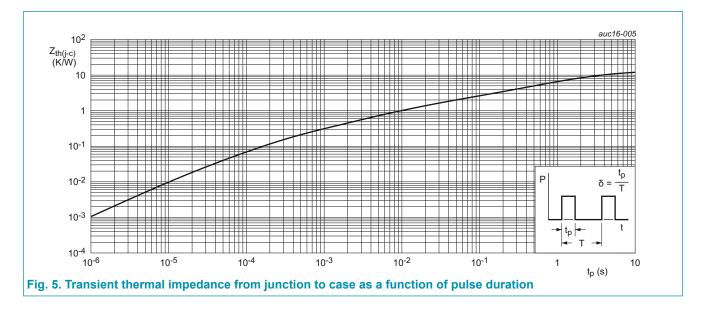
a = form factor = $I_{F(RMS)}/I_{F(AV)}$ Vo = 0.992 V; Rs = 0.0327 Ω Fig. 2. Forward power dissipation as a function of average forward current; sinusoidal waveform; maximum values



MUR560 Ultrafast power diode

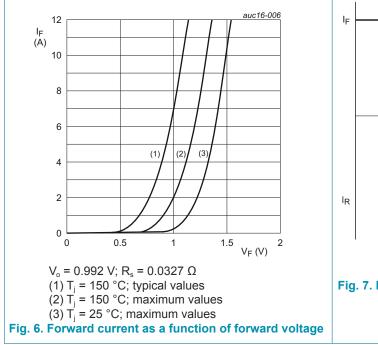
9. Thermal characteristics

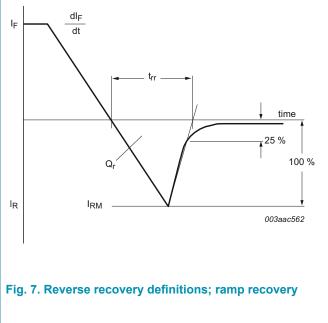
Table 6. Thermal characteristics								
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit	
$R_{\text{th(j-c)}}$	thermal resistance from junction to case	mounted on a minimum footprint printed-circuit board (FR4); <u>Fig. 5</u>		-	-	12	K/W	
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	mounted on a minimum footprint printed-circuit board (FR4)		-	75	-	K/W	



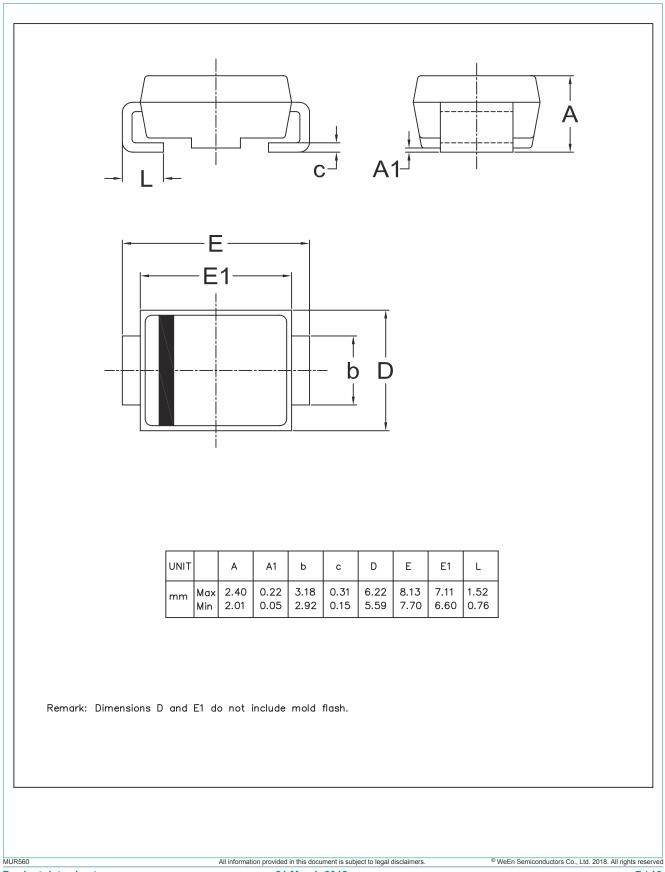
10. Characteristics

Table 7. Cl	naracteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
V _F	forward current	I _F = 5 A; T _j = 25 °C; <u>Fig. 6</u>	-	1.10	1.35	V
		I _F = 5 A; T _j = 150 °C; <u>Fig. 6</u>	-	0.9	1.15	V
I _R	reverse current	V _R = 600 V; T _j = 25 °C	-	-	3	μA
		V _R = 600 V; T _j = 150 °C	-	-	250	μA
Dynamic	characteristics	I				1
Q _r	reverse charge	I _F = 5 A; V _R = 400 V; dI _F /dt = 100 A/μs; T _j = 25 °C; <u>Fig. 7</u>	-	216	-	nC
		I _F = 5 A; V _R = 400 V; dI _F /dt = 100 A/μs; T _j = 125 °C; <u>Fig. 7</u>	-	420	-	nC
t _{rr}	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; \text{ d}_F/\text{d}t = 50 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$	-	45	-	ns
		$I_F = 0.5 \text{ A}; I_R = 1 \text{ A}; I_{R(meas)} = 0.25 \text{ A};$ $T_j = 25 \text{ °C}; \text{ Step recovery}$	-	-	65	ns
		$I_F = 5 \text{ A}; V_R = 400 \text{ V}; \text{ d}I_F/\text{d}t = 100 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$	-	64	-	ns
		I _F = 5 A; V _R = 400 V; dI _F /dt = 100 A/μs; T _j = 125 °C; <u>Fig. 7</u>	-	88	-	ns
I _{RM}	peak reverse recovery current	$I_F = 5 \text{ A}; V_R = 400 \text{ V}; \text{ d}I_F/\text{d}t = 100 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$	-	6.7	-	A
		I _F = 5 A; V _R = 400 V; dI _F /dt = 100 A/μs; T _j = 125 °C; <u>Fig. 7</u>	-	9.5	-	A
E _{as}	non-repetitive avalanche energy	I _R = 1.2 A; T _{j(init)} = 25 °C; L = 15 mH	10.8	-	-	mJ





11. Package outline



12. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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